

2829



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TRANSMITTAL FORM

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TRANSMITTAL FORM (to be used for all correspondence after initial filing)	Application Number	09/699,466	
	Filing Date	October 31, 2000	
	First Named Inventor	Shunpei YAMAZAKI et al.	
	Group Art Unit	2829	
	Examiner Name	A. Sarkar	
Total Number of Pages in This Submission		Attorney Docket Number	0756-2222

ENCLOSURES (check all that apply)

<input type="checkbox"/> Fee Transmittal Form <input type="checkbox"/> Fee Attached <input checked="" type="checkbox"/> Amendment / Reply <input checked="" type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input type="checkbox"/> Information Disclosure Statement <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Response to Missing Parts/Incomplete Application <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers (for an Application) <input type="checkbox"/> Drawing(s) <input type="checkbox"/> Declaration and Power of Attorney <input type="checkbox"/> Licensing-related Papers <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s)	<input type="checkbox"/> After Allowance Communication to Group <input type="checkbox"/> Appeal Communication to Board of Appeals and Interferences <input type="checkbox"/> Appeal Communication to Group (Appeal Notice, Brief, Reply Brief) <input type="checkbox"/> Proprietary Information <input type="checkbox"/> Status Letter <input checked="" type="checkbox"/> Other Enclosures 1. Change of Correspondence Address Form 2. 3. 4. 5. 6.
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Firm or Individual name	Eric J. Robinson Robinson Intellectual Property Law Office, P.C. PMB 955 21010 Southbank Street Potomac Falls, VA 20165
Signature	
Date	May 20, 2002

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of
Shunpei YAMAZAKI et al

Serial No. 09/699,466

Filed: October 31, 2000

For: MEHTOD FOR FABRICATING A)
A SEMICONDUCTOR DEVICE)



Art Unit: 2829

Examiner: A. Sarkar

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AMENDMENT

Honorable Commissioner of Patents
Washington, D.C. 20231

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Sir:

In response to the Office Action dated February 19, 2002 please amend the
above-identified application as follows:

IN THE CLAIMS:

Please amend claims 1, 4, 7, 11, 15, 20 and 26-28 as follows:

1. (Amended) A method for manufacturing a semiconductor device
comprising the steps of:
forming a semiconductor film on an insulating surface; and
forming a semiconductor island having a tapered shape by patterning said
semiconductor film, said tapered shape having an angle within a range of 20° to 50°
between a side thereof and an underlying surface,
wherein irradiation of laser light is performed after forming said
semiconductor film.

4. (Amended) A method for manufacturing a semiconductor device
comprising the steps of:
forming a semiconductor film on an insulating surface;